



Our Docket No: 42390P9482C

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: )  
)  
Takashi Kumamoto et al. ) Examiner: Thai, Luan C.  
)  
Application No: 10/616,827 ) Art Unit: 2827  
)  
Filed: July 10, 2003 )  
)  
For: Molded Flip Chip Package )

**RESPONSE TO OFFICE ACTION**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed May 7, 2004, Applicants respectfully request the Examiner to enter the following amendments and to consider the following remarks.

**FIRST CLASS CERTIFICATE OF MAILING**

I hereby certify that I am causing the above-referenced correspondence to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date of Deposit: July 14, 2004

Name of Person Mailing Correspondence: Debbie Peloquin

Debbie Peloquin  
Signature

7-14-04  
Date